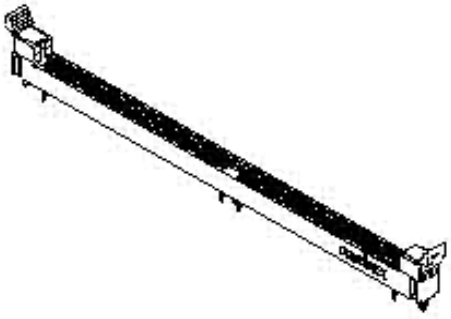


Part Number : 879780021
Product Description : 1.00mm Pitch DDR-2 DIMM Socket, Vertical, with Beveled Metal Pins, Very Low Profile Black Latches, 240 Circuits, 1.8V Center Voltage Key, 2.67mm Tail Length, 0.38µm Gold (Au) Plating, Lead-Free
Series Number : 87978
Status : Obsolete
Product Category : Memory Module Connectors

Obsolete

Documents and Resources

Specifications

PS-87978-001-001.pdf

Product Environment Compliance

Compliance

GADSL/IMDS	Compliant with Exemption 44; 34; 33
China RoHS	per SJ/T 11365-2006
EU ELV	Not Relevant
Low-Halogen Status	Not Low-Halogen per IEC 61249-2-21
REACH SVHC	Not Contained per D(2025)7771-DC (04 Feb 2026)
EU RoHS	Compliant per EU 2015/863

Compliance Statements

- EU RoHS
- REACH SVHC
- Low-Halogen

Industry Documents

- IPC 1752A Class C
- IPC 1752A Class D
- Molex Product Compliance Declaration

- IEC-62474
- chemSHERPA (xml)

Substances of Interest
- PFAS

EU RoHS Certificate of Compliance

Additional Product Compliance Information

Part Details

General

Status	Obsolete
Category	Memory Module Connectors
Series	87978
Description	1.00mm Pitch DDR-2 DIMM Socket, Vertical, with Beveled Metal Pins, Very Low Profile Black Latches, 240 Circuits, 1.8V Center Voltage Key, 2.67mm Tail Length, 0.38µm Gold (Au) Plating, Lead-Free
Component Type	Socket
JEDEC Outline	MO-237
Product Name	DDR2 DIMM
UPC	822350307130

Agency

CSA	LR19980
UL	E29179

Electrical

Current - Maximum per Contact	0.5A
Voltage Key	1.8V, Center
Voltage - Maximum	30V

Physical

Circuits (Loaded)	240
Circuits (maximum)	240

Obsolete

Durability (mating cycles max)	25
Entry Angle	Vertical (Top Entry)
Flammability	94V-0
Housing Color	Black
Keying to Mating Part	Yes
Latch Color	Black
Material - Metal	Brass, Phosphor Bronze
Material - Plating Mating	Gold
Material - Plating Termination	Tin
Material - Resin	High Temperature Thermoplastic
Net Weight	9.270/g
Packaging Type	Tray
PCB Retention	Yes
PCB Thickness - Recommended	1.60mm
PC Tail Length	2.67mm
Pitch - Mating Interface	1.00mm
Plating min - Mating	0.381µm
Plating min - Termination	2.540µm
Temperature Range - Operating	-10° to +85°C
Termination Interface Style	Through Hole

Solder Process Data

Max-Duration	10
Lead-Free Process Capability	WAVE
Max-Cycle	1
Max-Temp	265

Obsolete

Mates With / Use With

Mates with Part(s)

Description	Part Number
Mates With	JEDEC Standard 1.27mm Modules